SDLS195 – MARCH 1985 – REVISED MARCH 1988

'LS673

- **16-Bit Serial-In, Serial-Out Shift Register with 16-Bit Parallel-Out Storage Register**
- **Performs Serial-to-Parallel Conversion**

'LS674

- **16-Bit Parallel-In, Serial-Out Shift Register**
- **Performs Parallel-to-Serial Conversion**

description

SN54LS673, SN74LS673

The 'LS673 is a 16-bit shift register and a 16-bit storage register in a single 24-pin package. A three-state input/output (SER/Q15) port to the shift register allows serial entry and/or reading of data. The storage register is connected in a parallel data loop with the shift register and may be asynchronously cleared by taking the store-clear input low. The storage register may be parallel loaded with shift-register data to provide shift-register status via the parallel outputs. The shift register can be parallel loaded with the storage-register data upon command.

A high logic level at the chip-level ($\overline{CS}$) input disables both the shift-register clock and the storage register clock and places SER/Q15 in the high-impedance state. The store-clear function is not disabled by the chip select.

Caution must be exercised to prevent false clocking of either the shift register or the storage register via the chip-select input. The shift clock should be low during the low-to-high transition of chip select and the store clock should be low during the high-to-low transition of chip select.

SN54LS674, SN74LS674

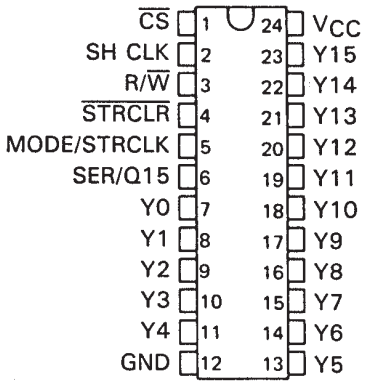
The 'LS674 is a 16-bit parallel-in, serial-out shift register. A three-state input/output (SER/Q15) port provides access for entering a serial data or reading the shift-register word in a recirculating loop.

The device has four basic modes of operation:

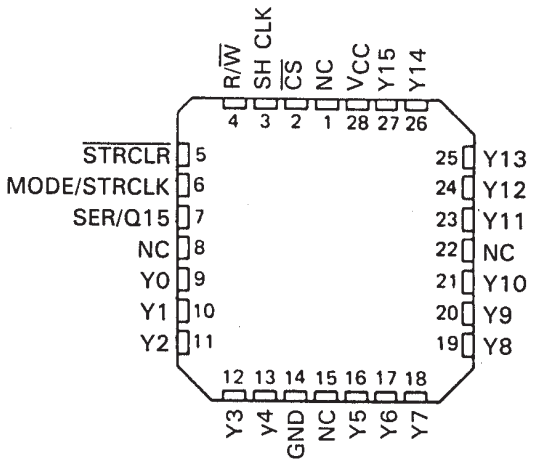
1) Hold (do nothing)
2) Write (serially via input/output)
3) Read (serially)
4) Load (parallel via data inputs)

Low-to-high-level changes at the chip select input should be made only when the clock input is low to prevent false clocking.

SN54LS673 . . . J OR W PACKAGE
SN74LS673 . . . DW OR N PACKAGE
(TOP VIEW)

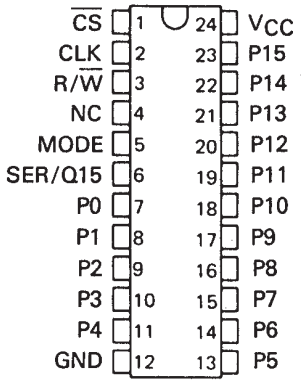


SN54LS673 . . . FK PACKAGE
(TOP VIEW)

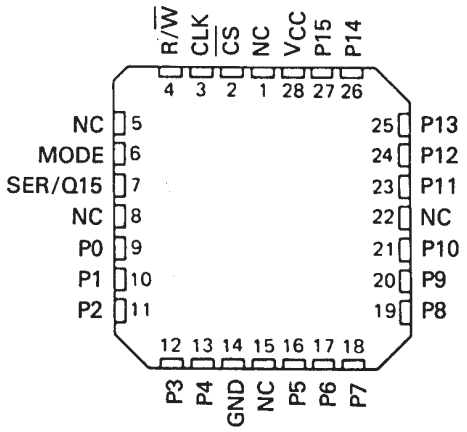


NC—No internal connection

SN54LS674 . . . J OR W PACKAGE
SN74LS674 . . . DW OR N PACKAGE
(TOP VIEW)



SN54LS674 . . . FK PACKAGE
(TOP VIEW)



'LS673
FUNCTION TABLE

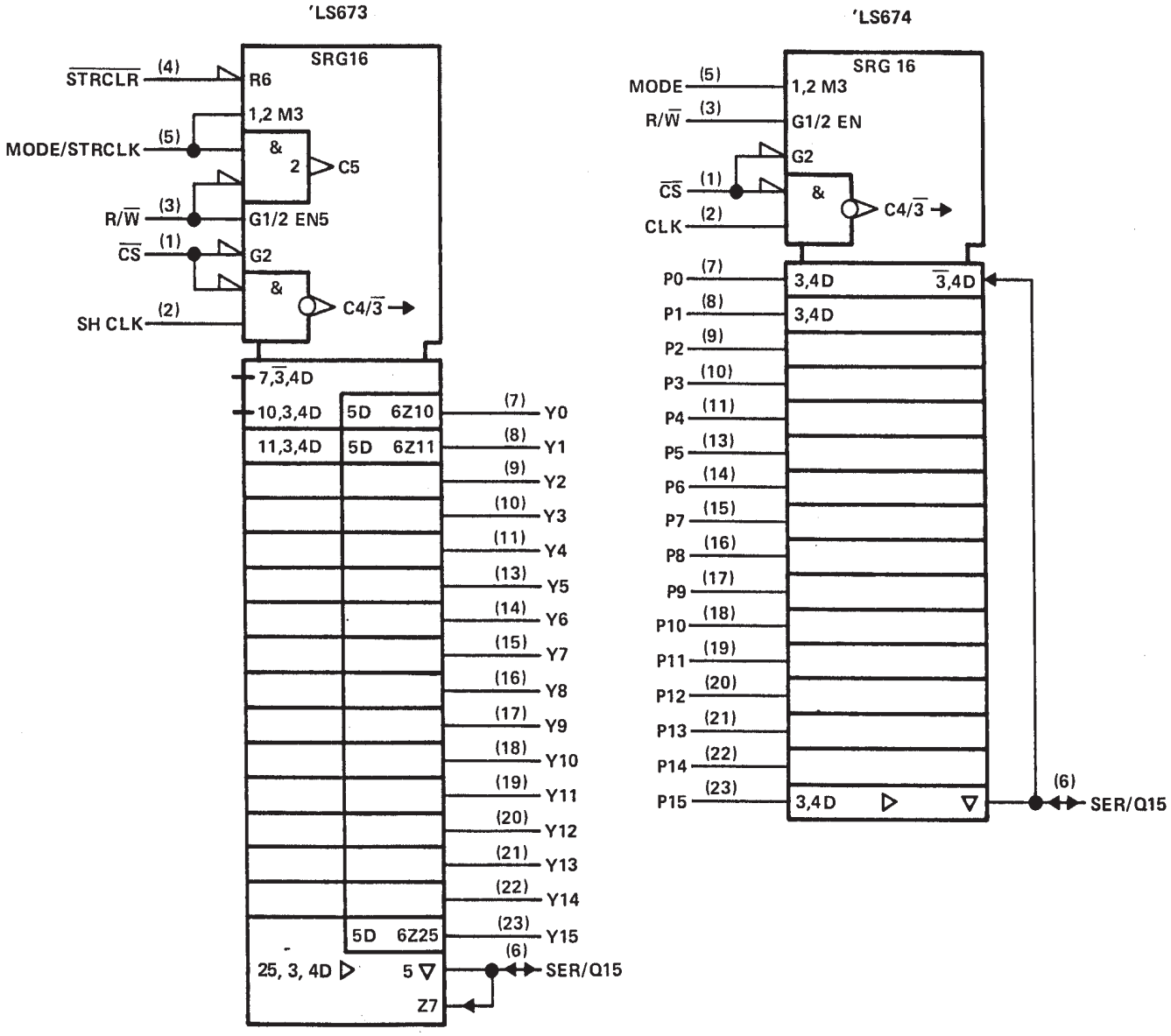
INPUTS					SER/ Q15	SHIFT REGISTER FUNCTIONS				STORAGE REGISTER FUNCTIONS	
$\overline{CS}$	R/$\overline{W}$	SH CLK	$\overline{STRCLR}$	MODE/ STRCLK		SHIFT	READ FROM SERIAL OUTPUT	WRITE INTO SERIAL INPUT	PARALLEL LOAD	CLEAR	LOAD
H	X	X	X	X	Z	NO	NO	NO	NO		NO
X	X	X	L	X						YES	
L	L	↓	X	X	Z	YES	NO	YES	NO		
L	H	X	X	X	Q15		YES	NO			NO
L	H	↓	X	L	Q14n	YES	YES	NO	NO		NO
L	H	↓	L	H	L	NO	YES		YES	YES	NO
L	H	↓	H	H	Y15n	NO	YES		YES	NO	NO
L	L	X	H	↑	Z		NO		NO	NO	YES

'LS674 FUNCTION TABLE

INPUTS				SER/ Q15	OPERATION
$\overline{CS}$	R/$\overline{W}$	MODE	CLK		
H	X	X	X	Z	Do nothing
L	L	X	↓	Z	Shift and write (serial load)
L	H	L	↓	Q14n	Shift and read
L	H	H	↓	P15	Parallel load

H = high level (steady state)
L = low level (steady state)
↑ = transition from low to high level
↓ = transition from high to low level
X = irrelevant (any input including transitions)
Z = high impedance, input mode
Q14n = content of 14th bit of the shift register before the most recent ↓ transition of the clock.
Q15 = present content of 15th bit of the shift register
Y15n = content of the 15th bit of the storage register before the most recent ↓ transition of the clock.
P15 = level of input P15

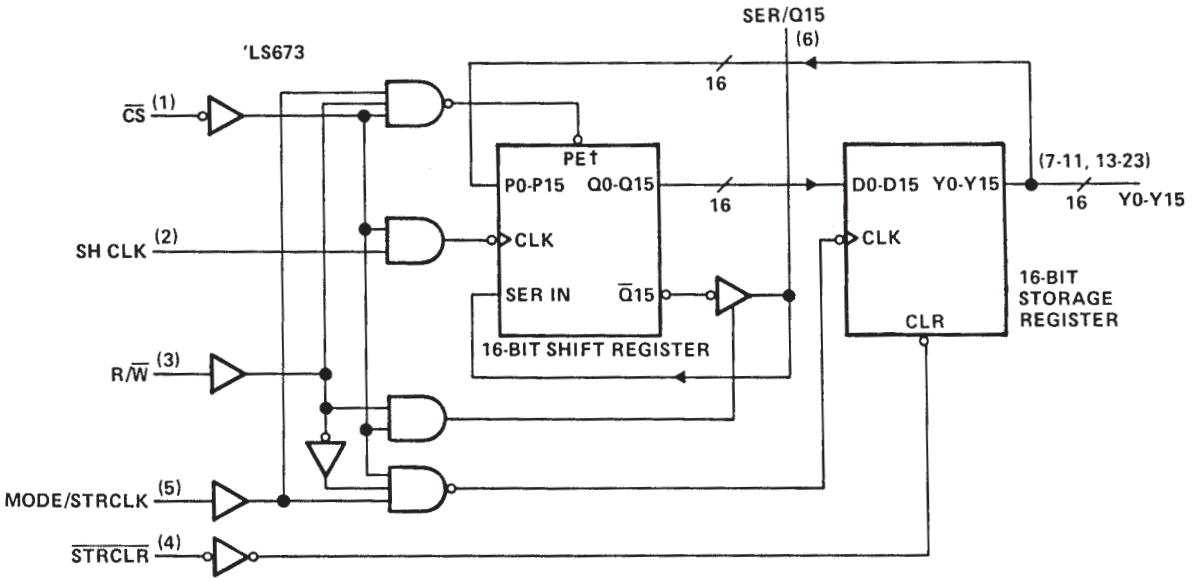
logic symbols†



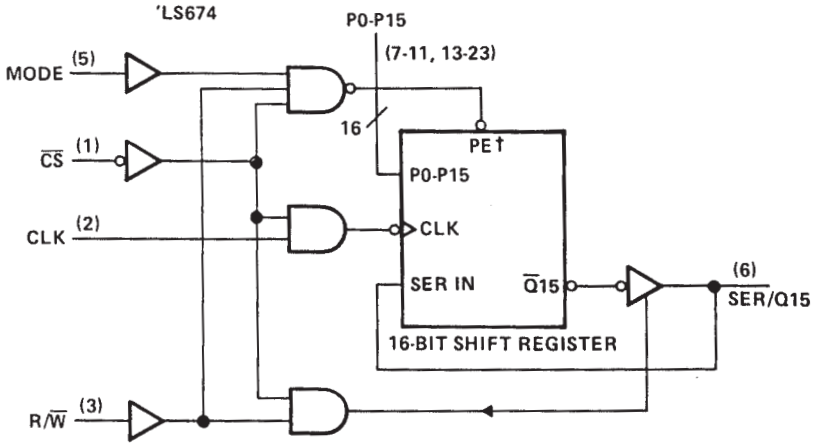
†These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.
Pin numbers shown are for DW, J, N, and W packages.

functional block diagrams

SN54LS673, SN74LS673

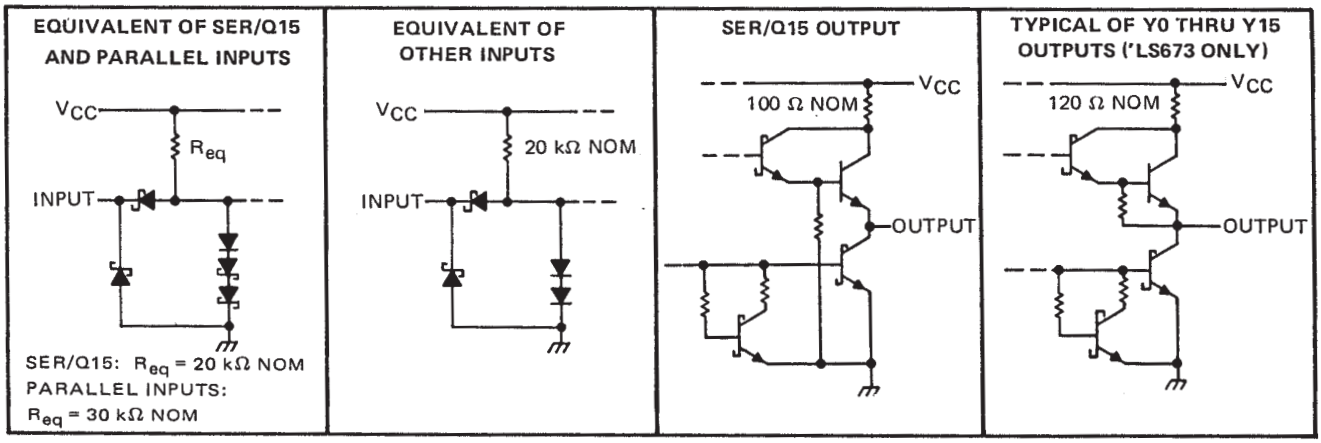


SN54LS674, SN74LS674



†When PE is active, data is synchronously parallel loaded into the shift registers from the 16 P inputs and no shifting takes place.
Pin numbers shown are for DW, J, N, and W packages.

schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage: SER/Q15 . . . . . 5.5 V
All others . . . . . 7 V
Off-state output voltage . . . . . 5.5 V
Operating free-air temperature range: SN54LS673, SN54LS674 . . . . . −55°C to 125°C
SN74LS673, SN74LS674 . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTE 1. Voltage values are with respect to network ground terminal.

recommended operating conditions

				SN54LS'			SN74LS'			UNIT
				MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage			4.5	5	5.5	4.75	5	5.25	V
I_{OH}	High-level output current	SER/Q15				−1			−2.6	mA
		Y0 thru Y15				−0.4			−0.4	
I_{OL}	Low-level output current	SER/Q15				12			24	mA
		Y0 thru Y15				4			8	
f_{clock}	Clock frequency			0		20	0		20	MHz
$t_{w(clock)}$	Width of clock input pulse			20			20			ns
$t_{w(clear)}$	Width of clear input pulse			20			20			ns
t_{su}	Setup time	SER/Q15		20			20			ns
		P0 thru P15		20			20			
		Mode		35			35			
		R/$\overline{W}$, $\overline{CS}$		35			35			
		SH CLK ↓ to Mode/STR CLK ↑ See Note 2		25			25			
t_h	Hold time	SER/Q15		0			0			ns
		P0 thru P15	'LS673	0			0			
			'LS674	5.0			5.0			
		Mode		0			0			
T_A	Operating free-air temperature			−55		125	0		70	°C

NOTE 2: This setup time ensures the storage register will see stable data from the shift register.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		SN54LS'			SN74LS'			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.7			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN,	I_I = −18 mA			−1.5			−1.5	V
V_{OH}	High-level output voltage	SER/Q15	V_{CC} = MIN,	V_{IH} = 2 V,	2.4	3.2		2.4	3.1		V
		Y0 thru Y15¶	V_{IL} = V_{IL}max,	I_{OH} = MAX	2.5	3.4		2.7	3.4		
V_{OL}	Low-level output voltage	SER/Q15	V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = V_{IL}max	I_{OL} = 12 mA		0.25	0.4		0.25	0.4	V
				I_{OL} = 24 mA					0.35	0.5	
		Y0 thru Y15¶		I_{OL} = 4 mA		0.25	0.4		0.25	0.4	
				I_{OL} = 8 mA					0.35	0.5	
I_{OZH}	Off-state output current, high-level voltage applied	SER/Q15	V_{CC} = MAX, V_{IL} = V_{IL}max,	V_{IH} = 2 V, V_O = 2.7 V			40			40	μA
I_{OZL}	Off-state output current, low-level voltage applied	SER/Q15	V_{CC} = MAX, V_{IL} = V_{IL}max,	V_{IH} = 2 V, V_O = 0.4 V			− 0.4			− 0.4	mA
I_I	Input current at maximum input voltage	SER/Q15	V_{CC} = MAX	V_I = 5.5 V			0.1			0.1	mA
		Others		V_I = 7 V			0.1			0.1	
I_{IH}	High-level input current	SER/Q15	V_{CC} = MAX,	V_I = 2.7 V			40			40	μA
		Others					20			20	
I_{IL}	Low-level input current		V_{CC} = MAX,	V_I = 0.4 V			−0.4			−0.4	mA
I_{OS}	Short-circuit output current§	SER/Q15	V_{CC} = MAX		−30		−130	−30		−130	mA
		Y0 thru Y15¶			−20		−100	−20		−100	
I_{CC}	Supply current	'LS673	V_{CC} = MAX			50	80		52	80	mA
		'LS674				25	40		25	40	

†For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions.
‡All typical values are at V_{CC} = 5 V, T_A = 25°C.
§Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.
¶'LS673 only.

switching characteristics, V_{CC} = 5 V, T_A = 25°C, see note 2

PARAMETER	'LS673		'LS674		TEST CONDITIONS	MIN	TYP	MAX	UNIT
	FROM	TO	FROM	TO					
f_{max}	SH CLK	SER/Q15	CLK	SER/Q15	R_L = 667 Ω, C_L = 45 pF	20	28		MHz
t_{PHL}	$\overline{STRCLR}$	Y0 thru Y15			R_L = 2 kΩ, C_L = 15 pF		25	40	ns
t_{PLH}	MODE/ STRCLK	Y0 thru Y15					28	45	
t_{PHL}							30	45	
t_{PLH}	SH CLK	SER/Q15	CLK	SER/Q15	R_L = 667 Ω, C_L = 45 pF		21	33	ns
t_{PHL}							26	40	
t_{PZH}	$\overline{CS}$, R/$\overline{W}$	SER/Q15	$\overline{CS}$, R/$\overline{W}$	SER/Q15	R_L = 667 Ω, C_L = 45 pF		30	45	ns
t_{PZL}							30	45	
t_{PHZ}	$\overline{CS}$, R/$\overline{W}$	SER/Q15	$\overline{CS}$, R/$\overline{W}$	SER/Q15	R_L = 667 Ω, C_L = 5 pF		25	40	ns
t_{PLZ}							25	40	

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-88602013A	ACTIVE	LCCC	FK	28	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-88602013A SNJ54LS673FK	Samples
5962-8860201JA	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201JA SNJ54LS673J	Samples
5962-8860201JA	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201JA SNJ54LS673J	Samples
5962-8860201LA	ACTIVE	CDIP	JT	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201LA SNJ54LS673JT	Samples
5962-8860201LA	ACTIVE	CDIP	JT	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201LA SNJ54LS673JT	Samples
5962-88607013A	ACTIVE	LCCC	FK	28	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-88607013A SNJ54LS674FK	Samples
5962-88607013A	ACTIVE	LCCC	FK	28	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-88607013A SNJ54LS674FK	Samples
5962-8860701JA	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860701JA SNJ54LS674J	Samples
5962-8860701JA	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860701JA SNJ54LS674J	Samples
SN54LS673J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54LS673J	Samples
SN54LS673J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54LS673J	Samples
SN54LS674J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54LS674J	Samples
SN54LS674J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	SN54LS674J	Samples
SN74LS673DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS673	Samples
SN74LS673DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS673	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LS674DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS674	Samples
SN74LS674DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS674	Samples
SN74LS674DWG4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS674	Samples
SN74LS674DWG4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS674	Samples
SNJ54LS673FK	ACTIVE	LCCC	FK	28	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-88602013A SNJ54LS 673FK	Samples
SNJ54LS673FK	ACTIVE	LCCC	FK	28	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-88602013A SNJ54LS 673FK	Samples
SNJ54LS673J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201JA SNJ54LS673J	Samples
SNJ54LS673J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201JA SNJ54LS673J	Samples
SNJ54LS673JT	ACTIVE	CDIP	JT	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201LA SNJ54LS673JT	Samples
SNJ54LS673JT	ACTIVE	CDIP	JT	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860201LA SNJ54LS673JT	Samples
SNJ54LS674FK	ACTIVE	LCCC	FK	28	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-88607013A SNJ54LS 674FK	Samples
SNJ54LS674FK	ACTIVE	LCCC	FK	28	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-88607013A SNJ54LS 674FK	Samples
SNJ54LS674J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860701JA SNJ54LS674J	Samples
SNJ54LS674J	ACTIVE	CDIP	J	24	1	TBD	Call TI	N / A for Pkg Type	-55 to 125	5962-8860701JA SNJ54LS674J	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

OTHER QUALIFIED VERSIONS OF SN54LS673, SN54LS674, SN74LS673, SN74LS674 :

- Catalog: SN74LS673, SN74LS674
- Military: SN54LS673, SN54LS674

NOTE: Qualified Version Definitions:

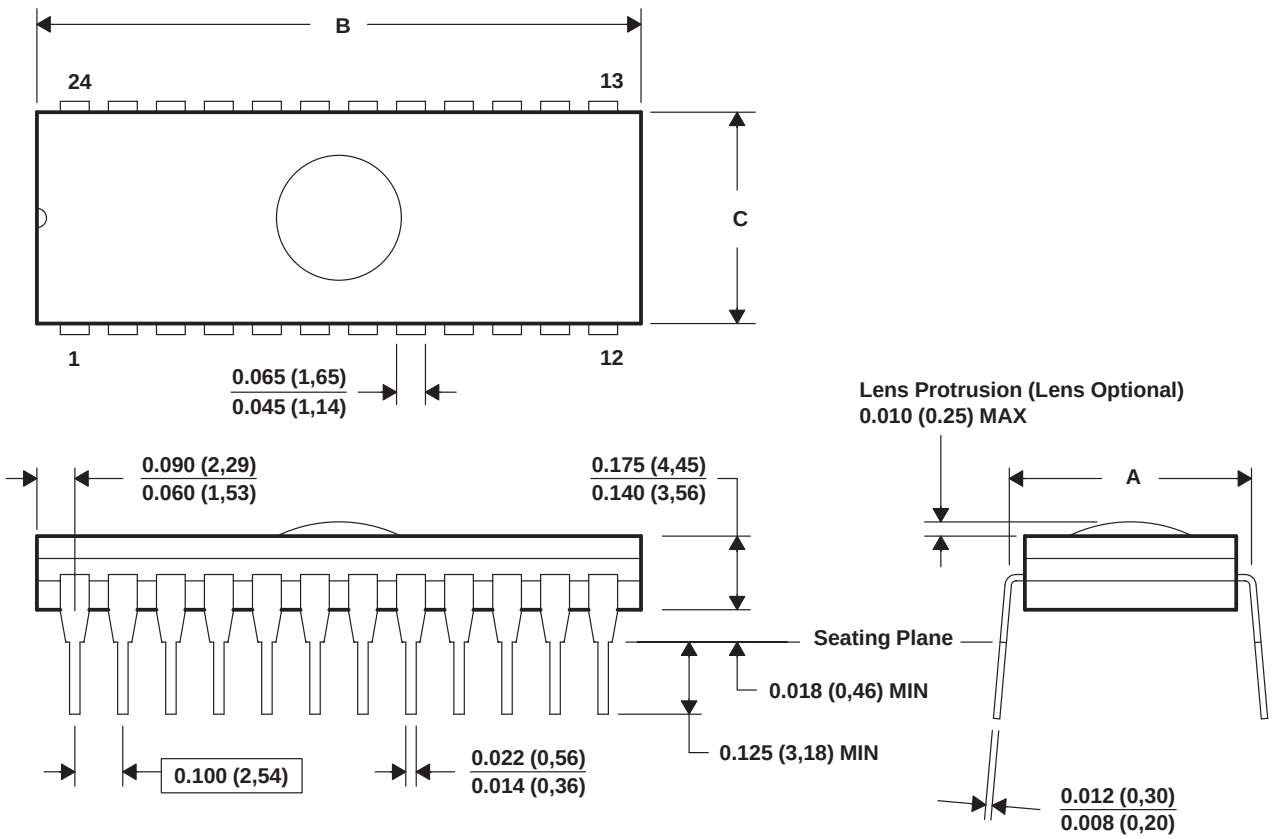
- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

MCDI004A – JANUARY 1995 – REVISED NOVEMBER 1997

J (R-GDIP-T**)

CERAMIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN



DIM \ PINS **		24		28		32		40	
		NARR	WIDE	NARR	WIDE	NARR	WIDE	NARR	WIDE
"A"	MAX	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)	0.624(15,85)
	MIN	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)	0.590(14,99)
"B"	MAX	1.265(32,13)	1.265(32,13)	1.465(37,21)	1.465(37,21)	1.668(42,37)	1.668(42,37)	2.068(52,53)	2.068(52,53)
	MIN	1.235(31,37)	1.235(31,37)	1.435(36,45)	1.435(36,45)	1.632(41,45)	1.632(41,45)	2.032(51,61)	2.032(51,61)
"C"	MAX	0.541(13,74)	0.598(15,19)	0.541(13,74)	0.598(15,19)	0.541(13,74)	0.598(15,19)	0.541(13,74)	0.598(15,19)
	MIN	0.514(13,06)	0.571(14,50)	0.514(13,06)	0.571(14,50)	0.514(13,06)	0.571(14,50)	0.514(13,06)	0.571(14,50)

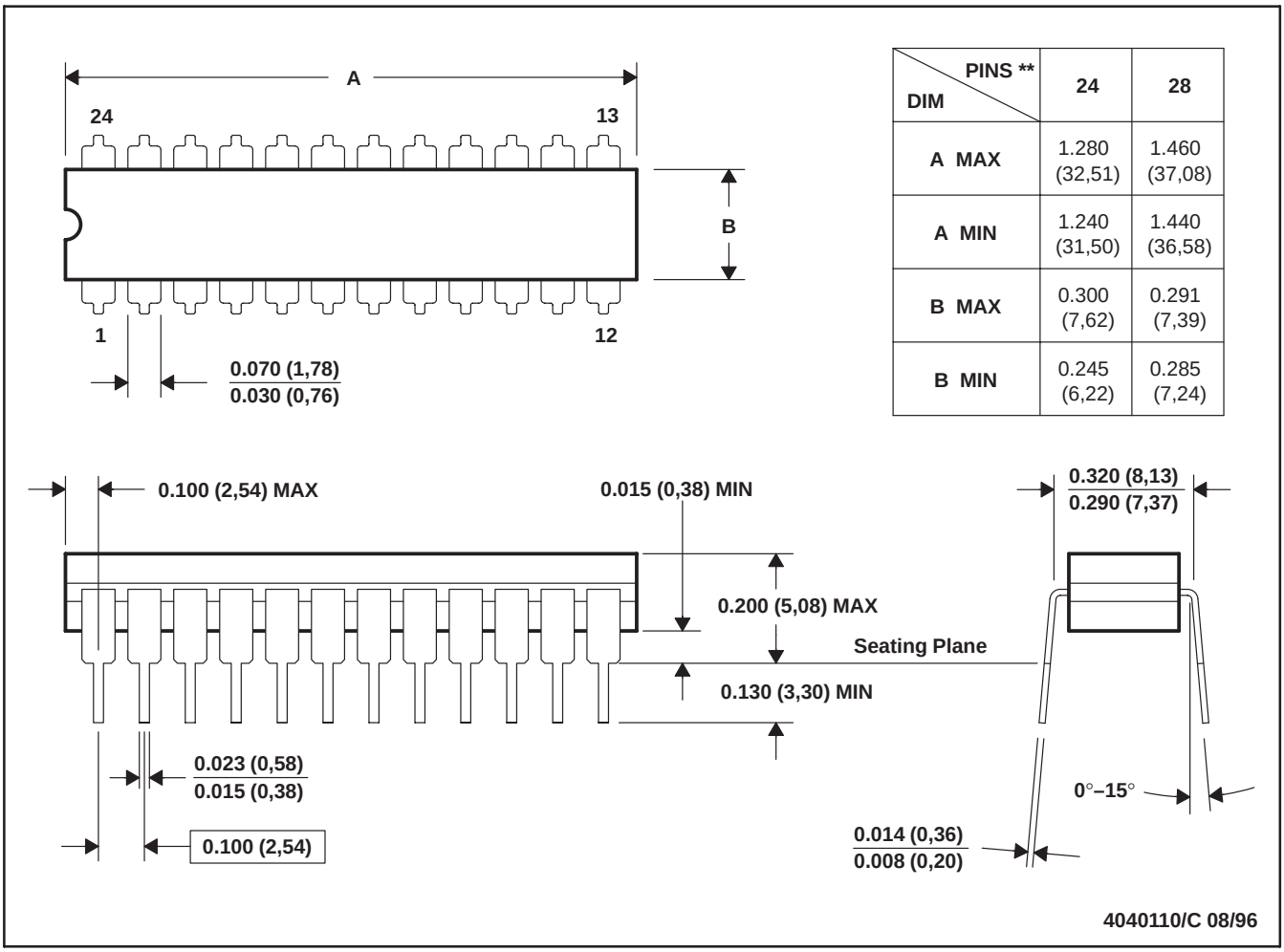
4040084/C 10/97

NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Window (lens) added to this group of packages (24-, 28-, 32-, 40-pin).
D. This package can be hermetically sealed with a ceramic lid using glass frit.
E. Index point is provided on cap for terminal identification.

MCER004A – JANUARY 1995 – REVISED JANUARY 1997

JT (R-GDIP-T)** **CERAMIC DUAL-IN-LINE**

24 LEADS SHOWN

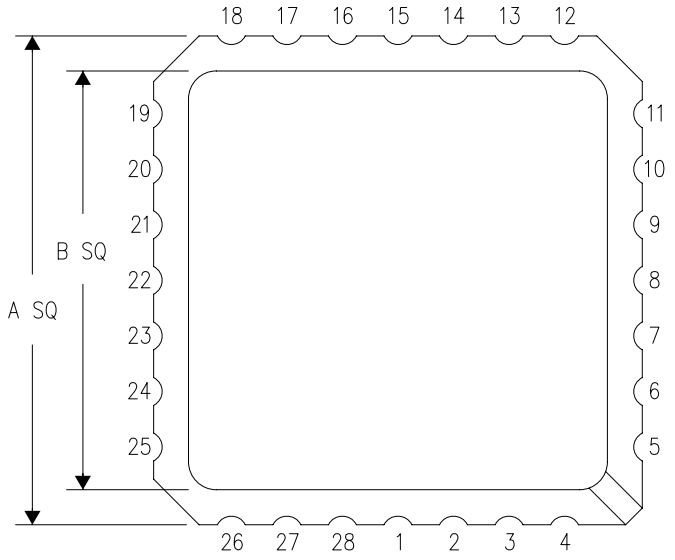


DIM \ PINS **	24	28
A MAX	1.280 (32,51)	1.460 (37,08)
A MIN	1.240 (31,50)	1.440 (36,58)
B MAX	0.300 (7,62)	0.291 (7,39)
B MIN	0.245 (6,22)	0.285 (7,24)

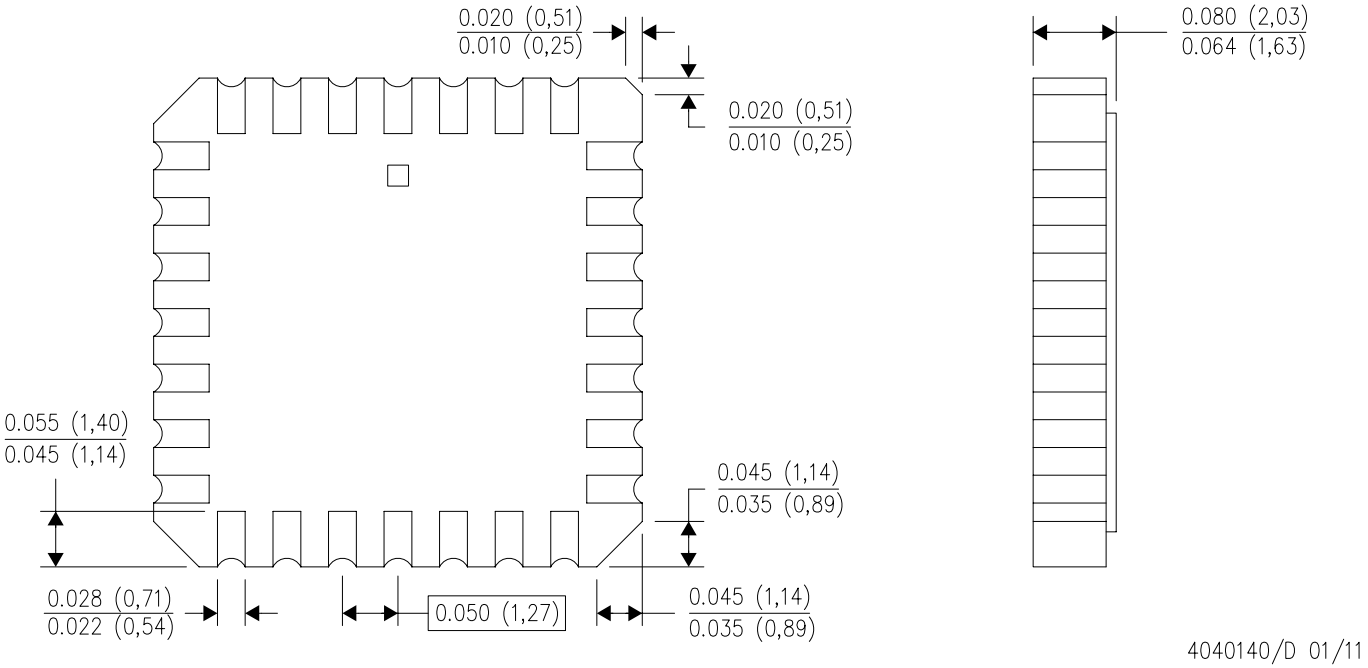
NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification.
E. Falls within MIL STD 1835 GDIP3-T24, GDIP4-T28, and JEDEC MO-058 AA, MO-058 AB

FK (S–CQCC–N**) LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



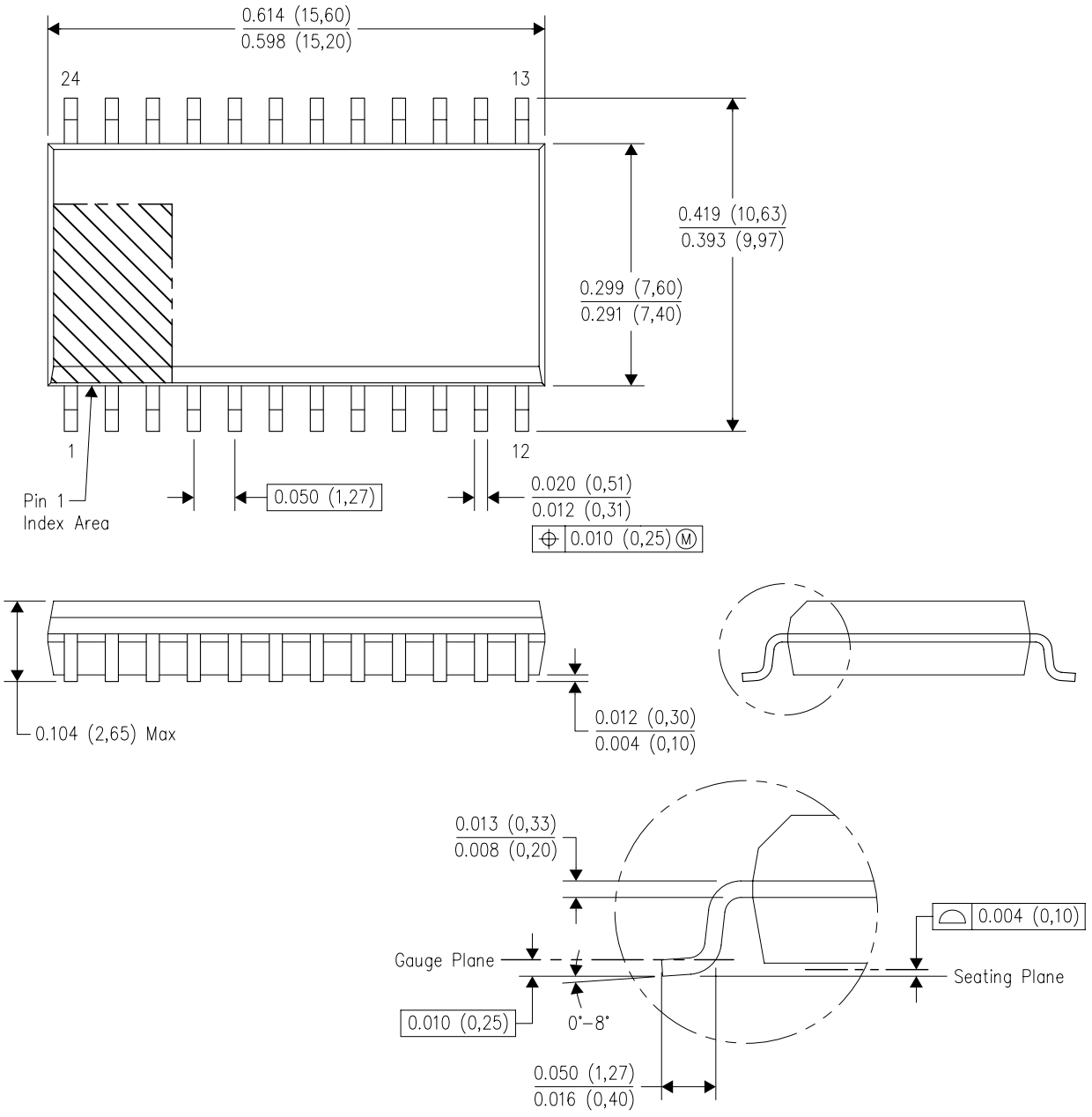
NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)



4040140/D 01/11

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package can be hermetically sealed with a metal lid.
D. Falls within JEDEC MS–004

DW (R–PDSO–G24) PLASTIC SMALL OUTLINE



NOTES:
A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M–1994.
B. This drawing is subject to change without notice.
C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
D. Falls within JEDEC MS–013 variation AD.

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